

# Integrated Relay, **Inductive Load Driver**

# **NUD3112**

This device is used to switch inductive loads such as relays, solenoids incandescent lamps, and small DC motors without the need of a free-wheeling diode. The device integrates all necessary items such as the MOSFET switch, ESD protection, and Zener clamps. It accepts logic level inputs thus allowing it to be driven by a large variety of devices including logic gates, inverters, and microcontrollers.

#### **Features**

- Provides a Robust Driver Interface Between D.C. Relay Coil and Sensitive Logic Circuits
- Optimized to Switch Relays of 12 V Rail
- Capable of Driving Relay Coils Rated up to 6.0 W at 12 V
- Internal Zener Eliminates the Need of Free-Wheeling Diode
- Internal Zener Clamp Routes Induced Current to Ground for Quieter **Systems Operation**
- Low V<sub>DS(ON)</sub> Reduces System Current Drain
- These Devices is Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### **Typical Applications**

- Telecom: Line Cards, Modems, Answering Machines, FAX
- Computers and Office: Photocopiers, Printers, Desktop Computers
- Consumer: TVs and VCRs, Stereo Receivers, CD Players, Cassette Recorders
- Industrial: Small Appliances, Security Systems, Automated Test Equipment, Garage Door Openers



SC-74 CASE 318F STYLE 7

### MARKING DIAGRAM



= Specific Device Code

= Date Code

= Pb-Free Package

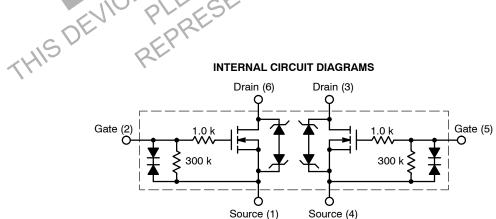
(Note: Microdot may be in either location)

### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
NUD3112DMT1G	SC-74 (Pb-Free)	3000 / Tape & Reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### INTERNAL CIRCUIT DIAGRAMS



### **NUD3112**

### **MAXIMUM RATINGS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Symbol	Rating	Value	Unit
V <sub>DSS</sub>	Drain to Source Voltage – Continuous	14	V <sub>dc</sub>
V <sub>GS</sub>	Gate to Source Voltage – Continuous	6	V <sub>dc</sub>
I <sub>D</sub>	Drain Current - Continuous	500	mA
Ez	Single Pulse Drain-to-Source Avalanche Energy (T <sub>Jinitial</sub> = 25°C)	50	mJ
TJ	Junction Temperature	150	°C
T <sub>A</sub>	Operating Ambient Temperature	-40 to 85	°C
T <sub>stg</sub>	Storage Temperature Range	-65 to +150	°C
P <sub>D</sub>	Total Power Dissipation (Note 1) Derating Above 25°C	1.8	mW/°C
P <sub>D</sub>	Total Power Dissipation (Note 1) Derating Above 25°C	3.0	mW/°C
$R_{\theta JA}$	Thermal Resistance Junction-to-Ambient (Note 1)	329	°C/W
ESD	Human Body Model (HBM) According to EIA/JESD22/A114	2000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Mounted onto minimum pad board.

TYPICAL ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

# TYPICAL ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Characteristic	Min	Тур	Max	Unit			
OFF CHARACTERISTICS								
V <sub>BRDSS</sub>	Drain to Source Sustaining Voltage (Internally Clamped) (ID = 10 mA)	14/\	16	17	V			
B <sub>VGSO</sub>	I <sub>g</sub> = 1.0 mA	-	-	8	V			
I <sub>DSS</sub>	Drain to Source Leakage Current $(V_{DS} = 12 \text{ V}, V_{GS} = 0 \text{ V}, T_A = 25^{\circ}\text{C})$ $(V_{DS} = 12 \text{ V}, V_{GS} = 0 \text{ V}, T_A = 85^{\circ}\text{C})$	-	-	20 40	μА			
I <sub>GSS</sub>	Gate Body Leakage Current $(V_{GS} = 3.0 \text{ V}, V_{DS} = 0 \text{ V})$ $(V_{GS} = 5.0 \text{ V}, V_{DS} = 0 \text{ V})$	-	-	35 65	μА			
ON CHARA	CTERISTICS							
V <sub>GS(th)</sub>	Gate Threshold Voltage $(V_{GS} = V_{DS}, I_D = 1.0 \text{ mA})$ $(V_{GS} = V_{DS}, I_D = 1.0 \text{ mA}, T_A = 85^{\circ}\text{C})$	0.8 0.8	1.2 -	1.4 1.4	V			
R <sub>DS(on)</sub>	Drain to Source On–Resistance $ \begin{array}{l} (I_D=250 \text{ mA}, V_{GS}=3.0 \text{ V}) \\ (I_D=500 \text{ mA}, V_{GS}=3.0 \text{ V}) \\ (I_D=500 \text{ mA}, V_{GS}=5.0 \text{ V}) \\ (I_D=500 \text{ mA}, V_{GS}=5.0 \text{ V}, T_A=85^\circ\text{C}) \\ (I_D=500 \text{ mA}, V_{GS}=5.0 \text{ V}, T_A=85^\circ\text{C}) \end{array} $	- - - -		1.2 1.3 0.9 1.3 0.9	Ω			
I <sub>DS(on)</sub>	Output Continuous Current $(V_{DS} = 0.25 \text{ V}, V_{GS} = 3.0 \text{ V})$ $(V_{DS} = 0.25 \text{ V}, V_{GS} = 3.0 \text{ V}, T_{A} = 85^{\circ}\text{C})$	300 200	400 -	-	mA			
9FS	Forward Transconductance (V <sub>OUT</sub> = 12.0 V, I <sub>OUT</sub> = 0.25 A)	350	490	-	mmhos			

### **NUD3112**

TYPICAL ELECTRICAL CHARACTERISTICS ( $T_A = 25^{\circ}C$  unless otherwise noted) (continued)

		,			
Symbol	Characteristic	Min	Тур	Max	Unit
DYNAMIC (	CHARACTERISTICS				
C <sub>iss</sub>	Input Capacitance (V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 0 V, f = 10 kHz)	-	23	_	pF
C <sub>oss</sub>	Output Capacitance (V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 0 V, f = 10 kHz)	-	30	_	pF
C <sub>rss</sub>	Transfer Capacitance ( $V_{DS}$ = 12.0 V, $V_{GS}$ = 0 V, f = 10 kHz)	-	7	_	pF

### **SWITCHING CHARACTERISTICS**

Symbol	Characteristic	1	Min	Тур	Max	Unit
	Propagation Delay Times:			6.1		nS
t <sub>PHL</sub>	High to Low Propagation Delay; Figure 1 ( $V_{DS} = 12 \text{ V}$ , $V_{GS} = 5.0 \text{ V}$ )		-	21	-	
t <sub>PLH</sub>	Low to High Propagation Delay; Figure 1 ( $V_{DS} = 12 \text{ V}$ , $V_{GS} = 5.0 \text{ V}$ )		-	91	-	
t <sub>f</sub>	Transition Times: Fall Time; Figure 1 ( $V_{DS} = 12 \text{ V}$ , $V_{GS} = 5.0 \text{ V}$ ) Rise Time; Figure 1 ( $V_{DS} = 12 \text{ V}$ , $V_{GS} = 5.0 \text{ V}$ )		_	36 61	SIGN	nS
<sup>(</sup> r	nise time; rigure i ( $v_{DS} = 12 \text{ v}, v_{GS} = 5.0 \text{ v}$ )			01	_	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

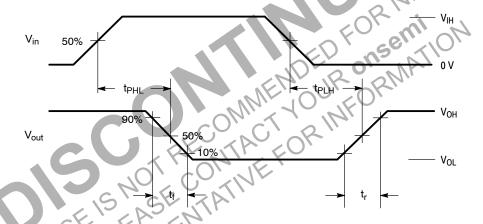
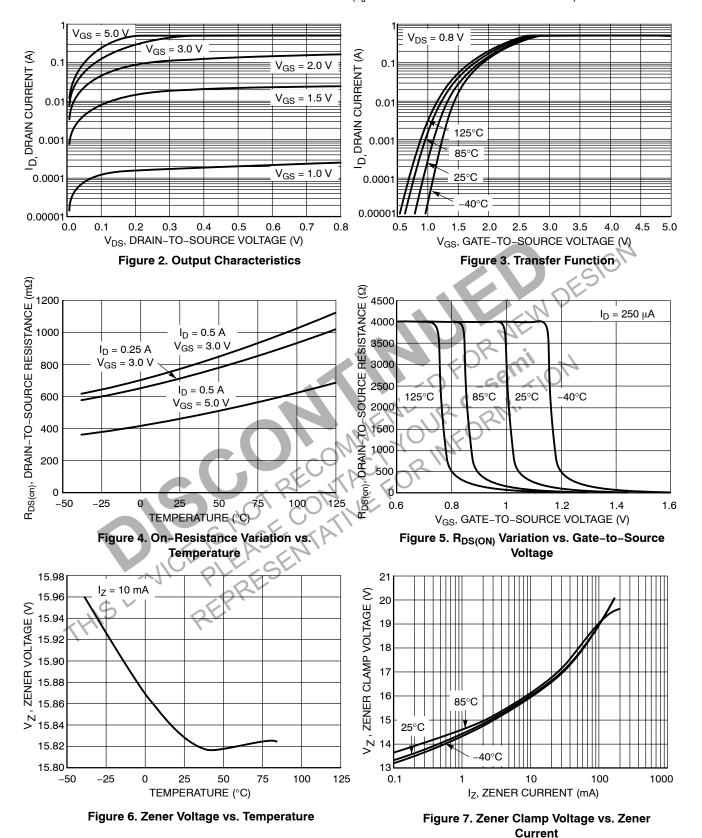


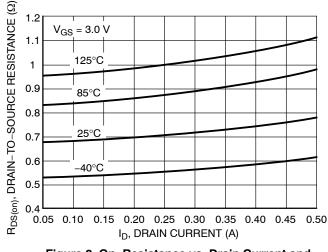
Figure 1. Switching Waveforms

### NUD3112

## TYPICAL PERFORMANCE CURVES (T<sub>J</sub> = 25°C UNLESS OTHERWISE SPECIFIED)



## $\textbf{TYPICAL PERFORMANCE CURVES} \text{ ($T_J$ = $25^{\circ}$C UNLESS OTHERWISE SPECIFIED) (continued)}$



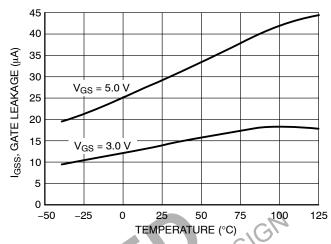


Figure 8. On-Resistance vs. Drain Current and Temperature

Figure 9. Gate Leakage vs. Temperature

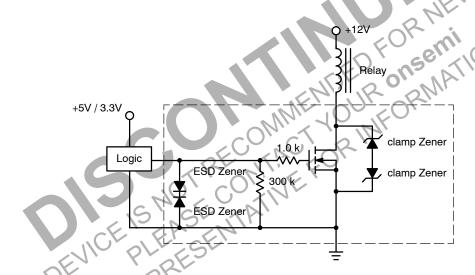


Figure 10. Typical Application Circuit





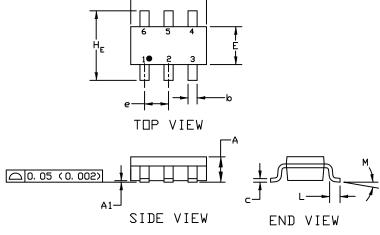
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**DATE 07 OCT 2021** 

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994
- 2. CONTROLLING DIMENSION: INCHES
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.

	MI	LLIMETER	25		INCHES	
DIM	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.
Α	0. 90	1. 00	1. 10	0. 035	0. 039	0. 043
A1	0. 01	0. 06	0.10	0. 001	0. 002	0. 004
ھ	0. 25	0. 37	0. 50	0. 010	0. 015	0. 020
U	0.10	0. 18	0. 26	0. 004	0. 007	0. 010
D	2. 90	3. 00	3. 10	0. 114	0. 118	0. 122
E	1. 30	1. 50	1. 70	0. 051	0. 059	0. 067
e	0. 85	0. 95	1. 05	0. 034	0. 037	0. 041
Η <sub>E</sub>	2. 50	2. 75	3. 00	0. 099	0. 108	0. 118
١	0. 20	0. 40	0. 60	0, 008	0. 016	0. 024
М	0*		10*	0*		10*



# GENERIC MARKING DIAGRAM\*



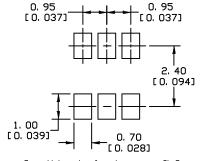
XXX = Specific Device Code

M = Date Code

not follow the Generic Marking.

= Pb-Free Package
 (Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may



For additional information on our Pb-Free strategy and soldering details, please download the UN Semiconductor Soldering and Mounting Techniques Reference Manual, SULDERRM/D.

SOLDERING FOOTPRINT

STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:	STYLE 6:
PIN 1. CATHODE	PIN 1. NO CONNECTION	PIN 1. EMITTER 1	PIN 1. COLLECTOR 2	PIN 1. CHANNEL 1	PIN 1. CATHODE
2. ANODE	2. COLLECTOR	2. BASE 1	2. EMITTER 1/EMITTER 2	2. ANODE	<ol><li>ANODE</li></ol>
<ol><li>CATHODE</li></ol>	<ol><li>EMITTER</li></ol>	<ol><li>COLLECTOR 2</li></ol>	<ol><li>COLLECTOR 1</li></ol>	<ol><li>CHANNEL 2</li></ol>	<ol><li>CATHODE</li></ol>
<ol><li>CATHODE</li></ol>	4. NO CONNECTION	4. EMITTER 2	4. EMITTER 3	<ol><li>CHANNEL 3</li></ol>	<ol><li>CATHODE</li></ol>
5. ANODE	<ol><li>COLLECTOR</li></ol>	5. BASE 2	<ol><li>BASE 1/BASE 2/COLLECTOR 3</li></ol>	<ol><li>CATHODE</li></ol>	<ol><li>CATHODE</li></ol>
<ol><li>CATHODE</li></ol>	6. BASE	<ol><li>COLLECTOR 1</li></ol>	6. BASE 3	<ol><li>CHANNEL 4</li></ol>	<ol><li>CATHODE</li></ol>
STYLE 7: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2	STYLE 8: PIN 1. EMITTER 1 2. BASE 2 3. COLLECTOR 2 4. EMITTER 2 5. BASE 1	STYLE 9: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1	STYLE 10: PIN 1. ANODE/CATHODE 2. BASE 3. EMITTER 4. COLLECTOR 5. ANODE	STYLE 11: PIN 1. EMITTER 2. BASE 3. ANODE/CATHODI 4. ANODE 5. CATHODE	≣
6. DRAIN 1	<ol><li>COLLECTOR 1</li></ol>	<ol><li>COLLECTOR 2</li></ol>	6. CATHODE	<ol><li>COLLECTOR</li></ol>	

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